



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Nikhil Vishwanath Kelkar

Attorney Docket No.: NSC1P300/P05882

Application No.: 10/824,903

Examiner: Shankle, A.

Filed: April 14, 2004

Group: 2891

Title: WAFER LEVEL PACKAGE DESIGN  
THAT FACILITATES TRIMMING AND  
TESTING

Confirmation No: 7593

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on July 12, 2006 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: \_\_\_\_\_

Laura M. Dean

**AMENDMENT A**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed April 19, 2006, please amend the above-identified patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims, which begin on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.